

## TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

ETAS ID: TM821544

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT		
<b>NATURE OF CONVEYANCE:</b>	SECURITY INTEREST		
<b>CONVEYING PARTY DATA</b>			
<b>Name</b>	<b>Formerly</b>	<b>Execution Date</b>	<b>Entity Type</b>
SAYSH CORPORATION		06/30/2023	Corporation: DELAWARE
<b>RECEIVING PARTY DATA</b>			
<b>Name:</b>	JPMORGAN CHASE BANK, N.A.		
<b>Street Address:</b>	383 Madison Avenue, 22nd Floor		
<b>City:</b>	New York		
<b>State/Country:</b>	NEW YORK		
<b>Postal Code:</b>	10017		
<b>Entity Type:</b>	National Banking Association: UNITED STATES		
<b>PROPERTY NUMBERS Total: 8</b>			
<b>Property Type</b>	<b>Number</b>	<b>Word Mark</b>	
<b>Serial Number:</b>	90867633	BY: SAYSH	
<b>Serial Number:</b>	90867619	SAYSH	
<b>Serial Number:</b>	90165625		
<b>Registration Number:</b>	6592046		
<b>Serial Number:</b>	90879153	SAYSH ONE	
<b>Serial Number:</b>	90165585	SAYSH	
<b>Serial Number:</b>	90975882	SAYSH	
<b>Serial Number:</b>	90882629	THE TRUTH OF HERS'	
<b>CORRESPONDENCE DATA</b>			
<b>Fax Number:</b>			
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>			
<b>Phone:</b>	2023704750		
<b>Email:</b>	ipteam@cogencyglobal.com		
<b>Correspondent Name:</b>	Joanna McCall		
<b>Address Line 1:</b>	1025 Connecticut Ave NW, Suite 712		
<b>Address Line 2:</b>	Cogency Global Inc.		
<b>Address Line 4:</b>	Washington, D.C. 20036		
<b>ATTORNEY DOCKET NUMBER:</b>	2044047		
<b>NAME OF SUBMITTER:</b>	Andrew Nash		

OP \$215.00 90867633

<b>SIGNATURE:</b>	/Andrew Nash/
<b>DATE SIGNED:</b>	07/03/2023
<b>Total Attachments: 9</b> source=Intellectual Property Security Agreement - Saysh(302567606.2)#page1.tif source=Intellectual Property Security Agreement - Saysh(302567606.2)#page2.tif source=Intellectual Property Security Agreement - Saysh(302567606.2)#page3.tif source=Intellectual Property Security Agreement - Saysh(302567606.2)#page4.tif source=Intellectual Property Security Agreement - Saysh(302567606.2)#page5.tif source=Intellectual Property Security Agreement - Saysh(302567606.2)#page6.tif source=Intellectual Property Security Agreement - Saysh(302567606.2)#page7.tif source=Intellectual Property Security Agreement - Saysh(302567606.2)#page8.tif source=Intellectual Property Security Agreement - Saysh(302567606.2)#page9.tif	

**INTELLECTUAL PROPERTY SECURITY AGREEMENT**

This Intellectual Property Security Agreement (as amended, restated, supplemented or otherwise modified from time to time, this “Agreement”) is entered into as of June 30, 2023, by and between JPMORGAN CHASE BANK, N.A. (“Lender”), as the lender party to the Credit Agreement referred to below, and SAYSH CORPORATION, a Delaware corporation (“Grantor”).

**RECITALS**

A. Lender has agreed to make certain advances of money and to extend certain financial accommodations (collectively, the “Loans”) to the Loan Parties (as defined in the Credit Agreement), in the amounts and manner set forth in that certain Credit and Security Agreement by and among Lender and the Loan Parties dated as of the same date hereof (as the same may be amended, modified or supplemented from time to time, collectively, the “Credit Agreement”; capitalized terms used herein are used as defined in the Credit Agreement). Lender is willing to make the Loans to the Loan Parties, but only upon the condition, among others, that Grantor shall grant to Lender a security interest in the Collateral, including certain Copyrights, Trademarks, and Patents (as each term is described below) to secure the obligations of Grantor under the Credit Agreement.

B. Pursuant to the terms of the Credit Agreement, Grantor has granted to Lender a security interest in all of Grantor’s right, title and interest, whether presently existing or hereafter acquired, in, to and under all of the Collateral.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, and intending to be legally bound, as collateral security for the prompt and complete payment when due of its obligations under the Credit Agreement, Grantor hereby represents, warrants, covenants and agrees as follows:

**AGREEMENT**

1. **Grant of Security Interest.** To secure the prompt payment and performance of the Secured Obligations, whether now existing or hereafter arising, Grantor hereby grants and pledges to Lender a security interest in all of Grantor’s right, title and interest in, to and under its intellectual property (all of which shall collectively be called the “Intellectual Property Collateral”), including, without limitation, the following:

(a) Any and all copyright rights, copyright applications, copyright registrations and like protections in each work or authorship and derivative work thereof, whether published or unpublished and whether or not the same also constitutes a trade secret, now or hereafter existing, created, acquired or held, including without limitation those set forth on Exhibit A attached hereto (collectively, the “Copyrights”);

(b) Any and all trade secrets, and any and all intellectual property rights in computer software and computer software products now or hereafter existing, created, acquired or held;

(c) Any and all design rights that may be available to Grantor now or hereafter existing, created, acquired or held;

(d) All patents, patent applications and like protections including, without limitation, improvements, divisions, continuations, renewals, reissues, extensions and continuations-in-part of the same, including without limitation the patents and patent applications set forth on Exhibit B attached hereto (collectively, the “Patents”);

(e) Any trademark and servicemark rights, whether registered or not, applications to register and registrations of the same and like protections, and the entire goodwill of the business of Grantor connected with and symbolized by such trademarks, including without limitation those set forth on Exhibit C attached hereto (collectively, the “Trademarks”);

(g) Any and all claims for damages by way of past, present and future infringements of any of the rights included above, with the right, but not the obligation, to sue for and collect such damages for said use or infringement of the intellectual property rights identified above;

(h) All licenses or other rights to use any of the Copyrights, Patents, or Trademarks, and all license fees and royalties arising from such use to the extent permitted by such license or rights;

(i) All amendments, extensions, renewals and extensions of any of the Copyrights, Trademarks, or Patents; and

(j) All proceeds and products of the foregoing, including without limitation all payments under insurance or any indemnity or warranty payable in respect of any of the foregoing.

2. Recordation. The parties hereto authorize and request that the Commissioner of Patents, the Commissioner for Trademarks and the Register of Copyrights of the United States record this security interest in the Intellectual Property Collateral.

3. Authorization. Grantor hereby authorizes Lender to (a) modify this Agreement unilaterally by amending the exhibits to this Agreement to include any Intellectual Property Collateral which Grantor obtains subsequent to the date of this Agreement, and (b) file a duplicate original of this Agreement containing amended exhibits reflecting such new Intellectual Property Collateral.

4. Loan Documents. This Agreement has been entered into pursuant to and in conjunction with the Credit Agreement, which is hereby incorporated by reference. The provisions of the Credit Agreement shall supersede and control over any conflicting or inconsistent provision herein. The rights and remedies of Lender with respect to the Intellectual Property Collateral are as provided by the Credit Agreement and related documents, and nothing in this Agreement shall be deemed to limit such rights and remedies.

5. Execution in Counterparts. This Agreement may be executed in counterparts (and by different parties hereto in different counterparts), each of which shall constitute an original, but all of which when taken together shall constitute a single contract. Delivery of an executed counterpart of a signature page to this Agreement by facsimile or in electronic (i.e., “pdf” or “tif” format) shall be effective as delivery of a manually executed counterpart of this Agreement.

6. Successors and Assigns. This Agreement will be binding on and shall inure to the benefit of the parties hereto and their respective successors and assigns.

7. Governing Law. This Agreement and any claim, controversy, dispute or cause of action (whether in contract or tort or otherwise) based upon, arising out of or relating to this Agreement and the transactions contemplated hereby and thereby shall be governed by, and construed in accordance with, the laws of the United States and the State of New York, without giving effect to any choice or conflict of law provision or rule (whether of the State of New York or any other jurisdiction).

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IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

GRANTOR:

Address:  
Saysh Corporation  
10100 Venice Blvd. #6969  
Culver City, CA 90232

**SAYSH CORPORATION**

DocuSigned by:  
By: Wes Felix  
Name: Wes Felix

Title: CEO

LENDER:

Address:  
  
JPMorgan Chase Bank, N.A.  
383 Madison Avenue, 22th Floor  
New York, NY 10017  
Attention: Alec Pillar

**JPMORGAN CHASE BANK, N.A.**

By: \_\_\_\_\_

Name: \_\_\_\_\_

Title: \_\_\_\_\_

*[Signature Page to Intellectual Property Security Agreement]*

**TRADEMARK**  
**REEL: 008121 FRAME: 0219**

IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

GRANTOR:

Address:  
Saysh Corporation  
10100 Venice Blvd. #6969  
Culver City, CA 90232

**SAYSH CORPORATION**

By: \_\_\_\_\_  
Name: \_\_\_\_\_

Title: \_\_\_\_\_

LENDER:

Address:  
  
JPMorgan Chase Bank, N.A.  
383 Madison Avenue, 22th Floor  
New York, NY 10017  
Attention: Alec Pillar

**JPMORGAN CHASE BANK, N.A.**

By: Alec Pillar

Name: Alec Pillar

Title: Authorized Officer

**[Signature Page to Intellectual Property Security Agreement]**

**TRADEMARK  
REEL: 008121 FRAME: 0220**

EXHIBIT A

Copyrights

<u>Description</u>	<u>Registration/ Application Number</u>	<u>Registration/ Application Date</u>
N/A	N/A	N/A

EXHIBIT B

Patents


<u>Description</u>	<u>Application Number/Registrati on Number</u>	<u>Application Date</u>	<u>Country</u>	<u>Status</u>
SHOE	29/801,289	2021-07-28	USA	Pending
SHOE	29/811,071	2021-10-11	USA	Pending



EXHIBIT C

Trademarks

<u>Description</u>	<u>Serial Application Number</u>	<u>Application/Registration Date</u>	<u>Country</u>	<u>Status</u>
BY: SAYSH	62478115	Reg. 8/7/2022	China	Registered
	90867633	App. 8/5/2021	USA	Allowed
<u>SAYSH</u>	WO1638576	Reg. 4/1/2022	Australia	Registered
	WO1638576	App. 8/23/2021	Canada	Pending
	58442663	Reg. 2/28/2022	China	Registered
	64933392	App. 5/27/2022	China	Pending
	64933392A	Reg. 3/7/2023	China	Registered
	64915068	App. 5/27/2022	China	Pending
	64915068A	Reg. 12/28/2022	China	Registered
	69328266	App. 1/31/2023	China	Pending
	69326852	App. 1/31/2023	China	Pending
	WO1638576	Reg. 6/1/2022	EU	Registered
	WO1638576	Reg. 12/9/2022	Japan	Registered
	WO1638576	App. 9/8/2022	Malaysia	Pending
	WO1638576	Reg. 8/15/2022	Mexico	Registered
	WO1638576	App. 9/6/2022	Singapore	Pending
	WO1638576	App. 3/9/2022	South Korea	Pending
	WO1638576	Reg. 4/5/2022	UK	Registered
	90867619	App. 8/5/2021	USA	Allowed
WO1638576	Reg. 1/13/2023	Vietnam	Registered	
WO1638576	Reg. 8/23/2021	WIPO	Registered	

<u>Description</u>	<u>Serial Application Number</u>	<u>Application/Registration Date</u>	<u>Country</u>	<u>Status</u>
SAYSH (stylized)  S A Y 2 H	60637655	Reg. 5/28/2022	China	Registered
SAYSH Misc Design  	WO1647516	Reg. 9/9/2022	Australia	Registered
	WO1647516	App. 2/1/2022	Canada	Pending
	WO1647516	App. 2/1/2022	EU	Registered
	WO1647516	App. 2/1/2022	Japan	Registered
	WO1647516	Reg. 9/22/2022	Mexico	Registered
	WO1647516	App. 3/9/2022	South Korea	Pending
	WO1647516	Reg. 5/26/2022	UK	Registered
	90165625	App. 9/8/2020	USA	Allowed
	6592046	Reg. 12/14/2021	USA	Registered
	WO1647516	Reg. 3/3/2023	Vietnam	Registered
	WO1647516	Reg. 2/1/2022	WIPO	Registered
SAYSH ONE	61184207	App. 12/7/2021	China	Published
	90879153	App. 8/12/2021	USA	Published
SAYSH Stylized/Design  S A Y 2 H	90165585	App. 9/8/2020	USA	Allowed
	90975882	Reg. 6604166	USA	Registered
SAYSH: BY ALLYSON FELIX	69024643	App. 12/28/2022	China	Published
	69023493	App. 12/28/2022	China	Published
THE TRUTH OF HERS'	90882629	App. 8/13/2021	USA	Allowed

<u>Description</u>	<u>Serial Application Number</u>	<u>Application/Registration Date</u>	<u>Country</u>	<u>Status</u>
霎时 (Sha Shi in Chinese)	65110508	Reg. 12/7/2022	China	Registered
	65084139	Reg. 12/7/2022	China	Registered